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27C256 262, 144-BIT (32,768 x 8) UV Erasable

CMOS PROM Military Qualified



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General Description

The 27C256 is a high-speed 256K UV erasable and electrically reprogrammable CMOS EPROM, ideally suited for applications where fast turnaround, pattern experimentation and low power consumption are important requirements.

The 27C256 is designed to operate with a single $\pm 5V$ power supply with $\pm 10\%$ tolerance. The CMOS design allows the part to operate over Military Temperature Range.

The 27C256 is packaged in a 28-pin dual-in-line package with transparent lid and a 32-pin windowed LCC. The transparent lid allows the user to expose the chip to ultraviolet light to erase the bit pattern. A new pattern can then be written electrically into the device by following the programming procedure.

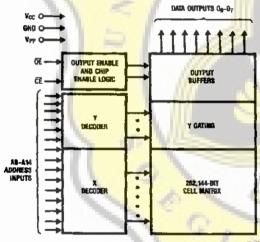
This EPROM is fabricated with National's proprietary, time proven CMOS double-poly silicon gate technology which combines high performance and high density with low power consumption and excellent reliability.

The 27C256 specified on this data sheet is fully compliant with MIL-STD-883, Revision C.

Features

- Clocked sense amps for fast access time down to 250 ns
- Low CMOS power consumption
 - Active power: 55 mW max
 - Standby power: 0.55 mW max
- Performance compatible to NSC800™ CMOS microprocessor
- Single 5V power supply
- Pin compatible with NMOS 256K EPROMs
- Fast and reliable programming (0.5 ms for most bytes)
- Static operation—no clocks required
- TTL, CMOS compatible inputs/outputs
- TRI-STATE® output
- Optimum EPROM for total CMOS systems
- Windowed DIP and LCC package options
- Specifications guaranteed over full military temperature range (-55°C to +125°C)
- This device is processed in compliance with SMD 86063, and the DIP version is dual marked

Block Diagram



Pin Names

A0-A14	Addresses
CE	Chip Enable
ŌĒ	Output Enable
00-07	Outputs
PGM	Program
NC	No Connect

TL/D/10332-1

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Connection Diagrams

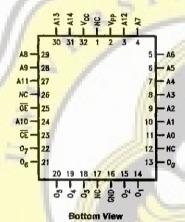
27C512	27C128	27C64	27 C 32	27C16
27512	27128	2764	2732	2716
A15	V _{PP}	Vpp		
A12	A12	A12		!!
A7	A7	A7	A7	A7
A6	A6	A6	A6	A6
A5	A5	A5	A5	A5
A4	A4	A4	A4	A4
A3	А3	А3	A3	A3
A2	A2	A2	A2	A2
A1	A1	A1	A1	A1
AO	AO	AO	AO	A0
00	00	00	00	00
01	01	O1	01	01
O2	O2	Q 2	02	02
GND	GND	GND	GND	GND

27C25	6Q
Dual-In-Line	Package

D	ual-In-Line Paci	ka	Be.
·	,	78	— væ
122	2	27	— AH
A7 —	3	25	— A13
A5 —	4	25	42
#5 - 	5	24	- ₩
"	4	25	ATI
13 m	7	22	— <u>ae</u>
A2 —	•	21	— A10
A1	9	20	— (E) PGB
AQ	ro.	19	⊢ 07
D# -	11	18	⊢o _r
01 -	12	17	⊢ 0s
D3 —	13	16	O4
PHD	и	16	- 0,
			T 10 (4600)

27C16			27C128	
2716	2732	2784	27128	27512
		v _{cc}	νœ	νœ
		PGM	PGM	A14
Vcc	Vœ	NC	A13	A13
8A	A8	AB	A8	A8
A9	A9	A9	A9	A9
VPP	Att	All	Alt	A11 -
ŌĒ	OE/V _{PP}	ŌĒ	Œ	OE/V _{PP}
A10	Aio	A10	A10	A10
CE/PGM	CE	ÇE	टह	ᅊ
07	07	07	07	07
OB	06	ОВ	06	Q6
O5	O5	O5	O5	O5
04	04	04	04	04
O3	O3	03	03	O3

NS Package Number J28AQ



TL/D/10332-6

NS Package Number EA32CQ

Military Temperature Range (-55°C to +125°C)
V_{CC} = 5V ±10%

Parameter/Order Number	Access Time
27C256Q250/883	250
27C256Q300/883	300
27C256Q350/883	350
27C256E250/883	250
27C256E300/883	300
27C256E35 <mark>0/883</mark>	350

Absolute Maximum Ratings (Note 1)

Temperature Under Bias

-55°C to +125°C

Storage Temperature

-65°C to +150°C

+6.5V to -0.6V

All Input Voltages with Respect to Ground (Note 10)

All Output Voltages

with Respect to Ground (Note 10)

V_{CC} + 1.0V to GND - 0.6V

V_{PP} Supply Voltage with Respect to Ground during Programming

+14.0V to -0.6V

Power Dissipation

Lead Temperature

(Soldering, 10 Seconds)

1.0W 300°C

V_{CC} Supply Voltage with Respect to Ground

+7.0V to -0.6V

Operating Conditions (Note 7)

Temperature Range (Tcase)

-55°C to + 125°C

V_{CC} Power Supply

5V ±10%

READ OPERATION

DC Electrical Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Units
lu	Input Load Current	$V_{1N} = V_{CC}$ or GND			10	μА
lio	Output Leakage Current	V _{OUT} = V _{CC} or GND, $\overline{\text{CE}} = V_{\text{JH}}$			10	μA
(Note 9)	V _{CC} Current (Active) TTL Inputs	$\overrightarrow{CE} = V_{IL}, f = 5 \text{ MHz}$ Inputs = V_{IH} or V_{IL} I/O = 0 mA		5	20	mA
ICC2 (Note 9)	V _{CC} Current (Active) CMOS Inputs	CE = GND, f = 5 MHz Inputs = V _{CC} or GND, I/O = 0 mA	3	3	10	mA
Iccse ₁	V _{CC} Current (Standby) TTL Inputs	CE = V _{IH}	St.	0.1	1	mA
I _{CCSB2}	V _{CC} Current (Standby) CMOS inputs	CE = V∞	33	0.5	100	μА
ipp	Vpp Load Current	V _{PP} = V _{CC}		100	200	μА
V _{IL}	Input Low Voltage		-0.1	700	8.0	V
V _{SH}	Input High Vollage	W .	2.0		V _{CC} + 1	V
V _{OL1}	Output Low Voltage	I _{OL} = 2.1 mA			0.45	ν
VoHi	Output High Voltage	I _{OH} = -400 μA	2.4			V
V _{OL2}	Oulput Low Voltage	$I_{OL} = 0 \mu A$			0.1	V
V _{CH2}	Output High Voltage	l _{OH} = 0 μ A	4.4		7000	V

AC Electrical Characteristics

			27C256					Units	
Symbol Parameter	Conditions 250		300		350				
_	10	A THE STREET	Min	Max	Min	Max	Min	Max	
tACC	Address to Output Delay	CE = OE = VIL		250		300		350	nş
t _{CE}	CE to Output Delay	OE = V _{IL}		250		300		350	nş
^t OE.	OE to Output Delay	CE = VIL		100		120		120	ns
t _{DF}	OE High to Output Float	CE = VIL	0	60	0	105	0	105	ns
t _{OH}	Output Hold from Addresses, CE or OE, Whichever Occurred First	CE = OE = V _{IL}	0		0	0	0		ns

Capacitance $T_A = +25^{\circ}C$, f = 1 MHz (Note 2)

Symbol	Parameter	Conditions	Тур	Max	Units
CiN	Input Capacitance	$V_{IN} = 0V$	6	10	pF
COUT	Output Capacitance	Vo = TUOV	9	14	pF

AC Test Conditions

Output Load

1 TTL Gate and C_L = 100 pF (Note 8)

Timing Measurement Reference Level Inputs

Outputs

0.8V and 2V 0.8V and 2V

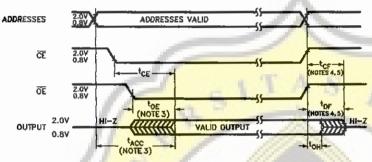
Input Rise and Fall Times

≤ 5 ns

Input Pulse Levels

0.45V to 2.4V

AC Waveforms (Notes 6, 7 and 9)



TL/D/10332-3

Note 1: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note 2: This parameter is only sampled and is not 100% tested.

Note 3: OE may be delayed up to IADC - log after the falling edge of CE without impacting IADC.

Note 4: The Ipp and Icp compare level is determined as follows:

High to TRI-STATE, the measured VOH1 (DC) - 0.10V;

Low to TRI-STATE, the measured VOL1 (DC) + 0.10V.

Note 5: TRI-STATE may be attained using OE or CE.

Note 6: The power switching characteristics of EPROMs require careful device decoupting. It is recommended that at least a 0.1 μF ceramic capacitor be used on every device between V_{CC} and GND.

Note 7: The outputs must be restricted to V_{CC} + 1.0V to avoid latch-up and device damag

Note & TTL Gate: I_{OL} ~ 1.6 mA, I_{OH} ~ ~400 μA. C_L: 100 pF includes fixture capacitance.

Note 9: V_{PP} may be connected to V_{CC} except during programming.

Note 10: Inputs and outputs can undershoot to -2.0V for 20 ns Max.

Symbol	Parameter	Conditions	Min	Тур	Max	Units
tas	Address Setup Time		2			μS
^t oes	OE Setup Time		2			μs
typs	V _{PP} Setup Time		2			μs
tvcs	V _{CC} Setup Time		2			μs
tDS CD	Data Setup Time		2			μѕ
^t AH	Address Hold Time	•	0			μS
ĮDК	Dala Hold Time		2			με
t _{DF}	Output Enable to Output Float Delay	CE = VIL	0		130	ns
tрw	Program Pulse Width		0.5	0.5	10	ns
t _{OE}	Data Valid from OE	CE = VIL	7.43		150	ns
lpp	Vpp Supply Current during Programming Pulse	CE = V _{1L} PGM = V _{1L}			30	mA
loc	V _{CC} Supply Current				10	mA
T _A	Temperature Ambient		20	25	30	°C
Vcc	Power Supply Voltage		5.75	6.0	6.25	V
Vpp	Programming Supply Voltage		12.2	13.0	13.3	V
Ψ _R	Input Rise, Fall time		5			ns
VIL	Input Low Voltage	-		0.0	0.45	V
V _{IH}	Input High Voltage	11	2.4	4.0		V
tiN	Input Timing Reference Voltage	1975	0.8	1.5	2.0	٧
t _{OUT}	Output Timing Reference Voltage	100	0.8	1.5	2.0	V

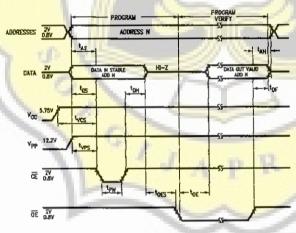
Note 1: National's standard product warranty applies only to devices programmed to specifications described herein.

Note 2: Voc must be applied simultaneously or before Vpp and removed simultaneously or after Vpp. The EPROM must not be inserted into or removed from a board with voltage applied to Vpp or Voc.

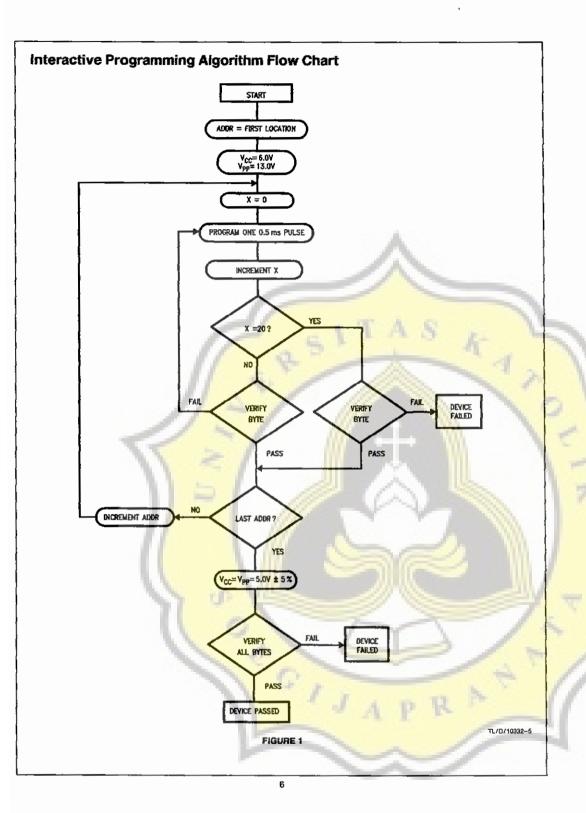
Note 3: The maximum absolute allowable voltage which may be applied to the Vpp pin during programming is 14V. Care must be taken when switching the Vpp supply to prevent any overshoot from exceeding this 14V maximum specification. At least a 0.1 µF capacitor is required across Vpp, Voc to GND to suppress spurious voltage transients which may demage the device.

Note 4: Programming and program verify are lasted with the Interactive Program Algorithm, at typical power supply voltages and timings. The Min and Max Limit Parameters are Design parameters, not Tested or guaranteed.

Programming Waveforms (Note 3)



TI,/D/10332-4



Functional Description

DEVICE OPERATION

The six modes of operation of the 27C256 are listed in Table I. It should be noted that all inputs for the six modes are at TTL levels. The power supplies required are $V_{\rm CC}$ and $V_{\rm PP}$. The $V_{\rm PP}$ power supply must be at 13.0V during the three programming modes, and must be at 5V in the other three modes. The $V_{\rm CC}$ power supply must be at 6V during the three programming modes, and at 5V in the other three modes.

Read Mode

The 27C256 has two control functions, both of which must be logically active in order to obtain data at the outputs. Chip Enable ($\overline{\text{CE}}$) is the power control and should be used for device selection. Output Enable ($\overline{\text{OE}}$) is the output control and should be used to gate data to the output pins, independent of device selection. Assuming that addresses are stable, address access time (t_{ACC}) is equal to the delay from $\overline{\text{CE}}$ to output (t_{CE}). Data is available at the outputs t_{OE} after the tailing edge of $\overline{\text{OE}}$, assuming that $\overline{\text{CE}}$ has been low and addresses have been stable for at least t_{ACC} — t_{OE} — $t_$

The sense amps are clocked for fast access time. Vcc should therefore be maintained at operating voltage during read and verify. If Vcc temporarily drops below the spec. voltage (but not to ground) an address transition must be performed after the drop to ensure proper output data.

Standby Mode

The 27C256 has a standby mode which reduces the active power dissipation by 99%, from 55 mW to 0.55 mW. The 27C256 is placed in the standby mode by applying a CMOS high signal to the CE input. When in standby mode, the outputs are in a high impedance state, independent of the OE input.

Output OR-Tying

Because 27C256s are usually used in larger memory arrays, National has provided a 2-line control function that accommodates this use of multiple memory connections. The 2line control function allows for:

- a) the lowest possible memory power dissipation, and
- b) complete assurance that output bus contention will not occur.

To most efficiently use these two control lines, it is recommended that \overline{CE} (pin 20) be decoded and used as the primary device selecting function, while \overline{CE} (pin 22) be made a common connection to all devices in the array and connected to the READ line from the system control bus. This asures that all deselected memory devices are in their low power standby modes and that the output pins are active only when data is desired from a particular memory device.

Programming

CAUTION: Exceeding 14V on pin 1 (Vpp will damage the 270256

Initially, and after each erasure, all bits of the 27C256 are in the "1" state. Data is introduced by selectively programming "0s" into the desired bit locations. Although only "0s" will be programmed, both "1s" and "0s" can be presented in the data word. The only way to change a "0" to a "1" is by ultraviolet light erasure.

The 27C256 is in the programming mode when the Vpp power supply is at 13.0V and OE is at V_{IH}. It is required that at least a 0.1 µF capacitor be placed across Vpp, V_{CC} to ground to suppress spurious voltage transients which may damage the device. The data to be programmed is applied 8 bits in parallel to the data output pins. The levels required for the address and data inputs are TTL.

When the address and data are stable, an active low TTL program pulse is applied to the CE/PGM input. A program pulse must be applied at each address location to be programmed. Any location may be programmed at any time-either individually, sequentially, or at random. The 27C256 is designed to be programmed with interactive programming, where each address is programmed with a series of 0.5 ms pulses until it verifies (up to a maximum of 20 pulses or 10 ms). The 27C256 must not be programmed with a DC signal applied to the CE/PGM input.

Programming multiple 27C256s in parallel with the same data can be easily accomplished due to the simplicity of the programming requirements. Like inputs of the paralleled 27C256s may be connected together when they are programmed with the same data. A low level TTL pulse applied to the CE/PGM input programs the paralleled 27C256s.

TABLE I. Mode Selection

Mode Pins	CE/PGM (20)	ŌE (22)	V _{PP} (1)	V _{CC} (28)	Outputs (11-13, 15-19)
Read	VIL	V _{1L}	5V	5V	D _{OUT}
Standby	VIH	Don't Care	5V	5V	Hi-Z
Program	V _{IL}	ViH	13.0V	6V	DiN
Program Verify	V _{{H}	VIL	13.0V	6V	Dout
Program Inhibit	VIH	V _{JH}	13.0V	6V	Hi-Z
Output Disable	Don't Care	VIH	5V	57	Hi-Z

Functional Description (Continued)

Program (nhibit

Programming multiple 27C256s in parallel with different data is also easily accomplished. Except for \overline{CE} all like inputs (including \overline{OE}) of the parallel 27C256s may be common. A TTL low level program pulse applied to an 27C256's. $\overline{CE/PGM}$ input with Vpp at 13.0V will program that 27C256. A TTL high level \overline{CE} input inhibits the other 27C256s from being programmed.

Program Verify

A verify should be performed on the programmed bits to determine whether they were correctly programmed. The verify may be performed with $V_{\rm PP}$ at 13.0V. $V_{\rm PP}$ must be at $V_{\rm CC}$, except during programming and program verify.

ERASURE CHARACTERISTICS

The erasure characteristics of the 27C256 are such that erasure begins to occur when exposed to light with wavelengths shorter than approximately 4000 Angstroms (Å). It should be noted that sunlight and certain types of fluorescent lamps have wavelengths in the 3000Å-4000Å range.

After programming, opaque labels should be placed over the 27C256's window to prevent unintentional erasure. Covering the window will also prevent temporary functional failure due to the generation of photo currents.

The recommended erasure procedure for the 27C256 is exposure to short wave ultraviolet light which has a wavelength of 2537 Angstroms (Å). The integrated dose (i.e., UV intensity × exposure time) for erasure should be a minimum of 15W-sec/cm².

The 27C256 should be placed within 1 inch of the lamp tubes during erasure. Some lamps have a filter on their

tubes which should be removed before erasure. Table II shows the minimum 27C256 erasure time for various light intensities.

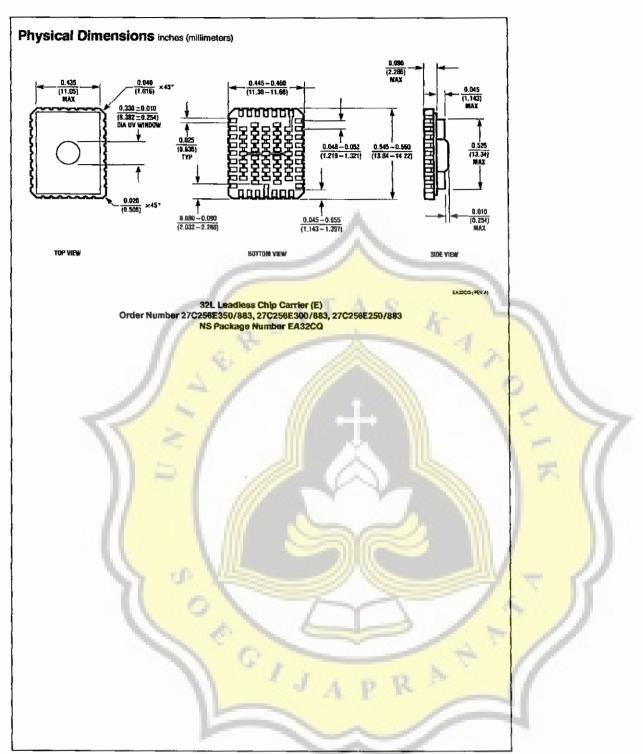
An erasure system should be calibrated periodically. The distance from lamp to unit should be maintained at one inch. The erasure time increases as the square of the distance. (If distance is doubled the erasure time increases by a factor of 4.) Lamps lose intensity as they age. When a lamp is changed, the distance has changed or the lamp has aged, the system should be checked to make certain full erasure is occurring. Incompete erasure will cause symptoms that can be misleading. Programmers, components, and even system designs have been erroneously suspected when incomplete erasure was the problem.

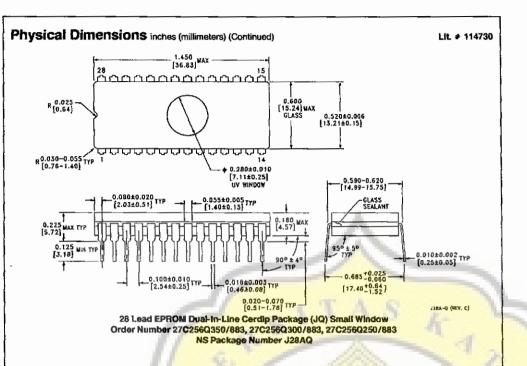
SYSTEM CONSIDERATION

The power switching characteristics of EPROMs require careful decoupling of the devices. The supply current, I_{CC}, has three segments that are of interest to the system designer—the standby current level, the active current level, and the transient current peaks that are produced by voltage transitions on input pins. The magnitude of these transient current peaks is dependent on the output capacitance loading of the device. The associated V_{CC} transient voltage peaks can be suppressed by properly selected decoupling capacitors. It is recommended that at least a 0.1 µF ceramic capacitor be used on every device between V_{CC} and GND. This should be a high frequency capacitor of low inherent inductance. In addition, at least a 4.7 µF bulk electrolytic capacitor should be used between V_{CC} and GND for each eight devices. The bulk capacitor should be located near where the power supply is connected to the array. The purpose of the bulk capacitor is to overcome the voltage drop caused by the inductive effects of the PC board traces.

TABLE II. Minimum 27C256 Erasure Time

Light intensity (Micro/Watts/cm²)	Erasure Time (Minutes)	
15,000	20	
10,000	25	
5,000	50	





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